SN54HCT240, SN74HCT240 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

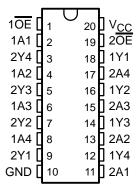
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- Operating Voltage Range of 4.5 V to 5.5 V
- **High-Current Outputs Drive Up To 15 LSTTL Loads**
- Low Power Consumption, 80-μA Max I_{CC}
- Typical $t_{pd} = 12 \text{ ns}$
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 µA Max
- Inputs Are TTL-Voltage Compatible
- 3-State Outputs Drive Bus Lines or Buffer **Memory Address Registers**

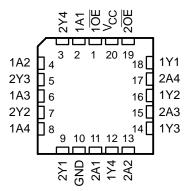
description/ordering information

These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The 'HCT240 devices are organized as two 4-bit buffers/drivers with separate output-enable (\overline{OE}) inputs. When \overline{OE} is low, the device passes inverted data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

SN54HCT240 . . . J OR W PACKAGE SN74HCT240 . . . DW, N, NS, OR PW PACKAGE (TOP VIEW)



SN54HCT240 . . . FK PACKAGE (TOP VIEW)



ORDERING INFORMATION

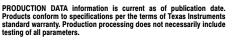
TA	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – N	Tube	SN74HCT240N	SN74HCT240N
	0010 014	Tube	SN74HCT240DW	LIOTO 40
	SOIC - DW	Tape and reel	SN74HCT240DWR	HCT240
–40°C to 85°C	SOP - NS	Tape and reel	SN74HCT240NSR	HCT240
	TOOOD DW	Tube	SN74HCT240PW	LITO40
	TSSOP – PW	Tape and reel	SN74HCT240PWR	HT240
	CDIP – J	Tube	SNJ54HCT240J	SNJ54HCT240J
-55°C to 125°C	CFP – W	Tube	SNJ54HCT240W	SNJ54HCT240W
	LCCC - FK Tube		SNJ54HCT240FK	SNJ54HCT240FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



testing of all parameters.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

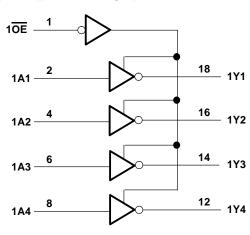


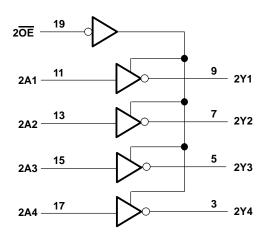
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FUNCTION TABLE (each buffer/driver)

INPU	JTS	OUTPUT
OE	Α	Y
L	Н	L
L	L	Н
Н	Χ	Z

logic diagram (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	DW package N package NS package	±20 mA ±20 mA ±35 mA ±70 mA 58°C/W 69°C/W 60°C/W
Storage temperature range, T _{stq}	PW package	83°C/W
otorago tomporataro rango, istg		. 55 5 10 100 6

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



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recommended operating conditions (see Note 3)

			SN	SN54HCT240			SN74HCT240		
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	V _{CC} = 4.5 V to 5.5 V	2			2			V
VIL	Low-level input voltage	V _{CC} = 4.5 V to 5.5 V			0.8			8.0	V
٧ _I	Input voltage		0		VCC	0		VCC	V
VO	Output voltage		0		VCC	0		VCC	V
Δt/Δν	Input transition rise/fall time				500			500	ns
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		T .,	T _A = 25°C			SN54HCT240		SN74HCT240		
PARAMETER			v _{CC}	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
V	\(\frac{1}{2} \rightarrow \frac{1}{2} \rightarrow \fra	I _{OH} = -20 μA	451/	4.4	4.499		4.4		4.4		.,
Voн	VI = VIH or VIL	$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		V
.,		$I_{OL} = 20 \mu A$	1,5,7		0.001	0.1		0.1		0.1	V
VoL	$V_I = V_{IH}$ or V_{IL}	$I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	
lį	$V_I = V_{CC}$ or 0		5.5 V		±0.1	±100		±1000		±1000	nA
loz	$V_O = V_{CC}$ or 0,	$V_I = V_{IH}$ or V_{IL}	5.5 V		±0.01	±0.5		±10		±5	μΑ
ICC	$V_I = V_{CC}$ or 0,	IO = 0	5.5 V			8		160		80	μΑ
ΔI _{CC} †	One input at 0.5 V Other inputs at 0 o		5.5 V		1.4	2.4		3		2.9	mA
Ci			4.5 V to 5.5 V		3	10		10		10	pF

[†] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	ТО	\ ,	T,	4 = 25°C	;	SN54H	CT240	SN74H	CT240	LINUT	
PARAMETER	(INPUT)	(OUTPUT)	ν _{CC}	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
			4.5 V		13	25		37		32		
^t pd	Α	Y	5.5 V		12	23		33		29	ns	
,		.,	4.5 V		21	35		53		44		
^t en	ŌĒ	Y	5.5 V		19	32		48		40	ns	
		Y	4.5 V		19	35		53		44		
^t dis	ŌĒ		5.5 V		18	32		48		40	ns	
t _t		,	V	4.5 V		8	12		18		15	
		Y	Y	5.5 V		7	11		16		14	ns



SN54HCT240, SN74HCT240 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

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switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 1)

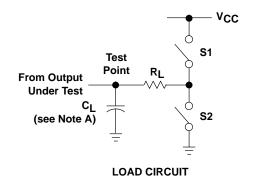
DADAMETED	FROM	TO (OUTPUT)	м то		T,	չ = 25°C	;	SN54H	CT240	SN74H	CT240	
PARAMETER	(INPUT)		νcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
		V	4.5 V		20	42		63		53	ns	
^t pd	A	Y	5.5 V		19	38		56		48		
	ŌĒ	Y	4.5 V		25	52		79		65		
^t en	OE		5.5 V		22	47		71		59	ns	
t _t		Y	4.5 V		17	42		63		53		
			5.5 V		14	38		57		48	ns	

operating characteristics, $T_A = 25^{\circ}C$

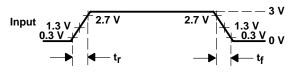
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	40	pF



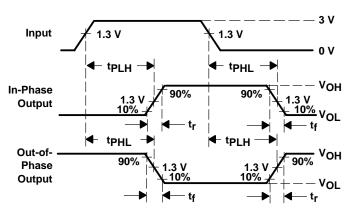
PARAMETER MEASUREMENT INFORMATION

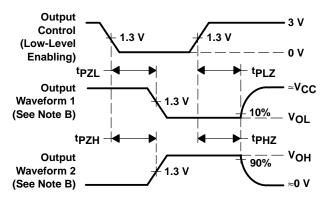


PARAI	METER	RL	CL	S1	S2	
	tPZH 1 kΩ or		Open	Closed		
^t en	^t PZL	1 K22	150 pF	Closed	Open	
4	tPHZ	1 k Ω	50 pF	Open	Closed	
^t dis	tPLZ	1 K22	50 pr	Closed	Open	
t _{pd} or	t _t	_	50 pF or 150 pF	Open	Open	



VOLTAGE WAVEFORM INPUT RISE AND FALL TIMES





VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT RISE AND FALL TIMES

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_r = 6$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



14 LEADS SHOWN



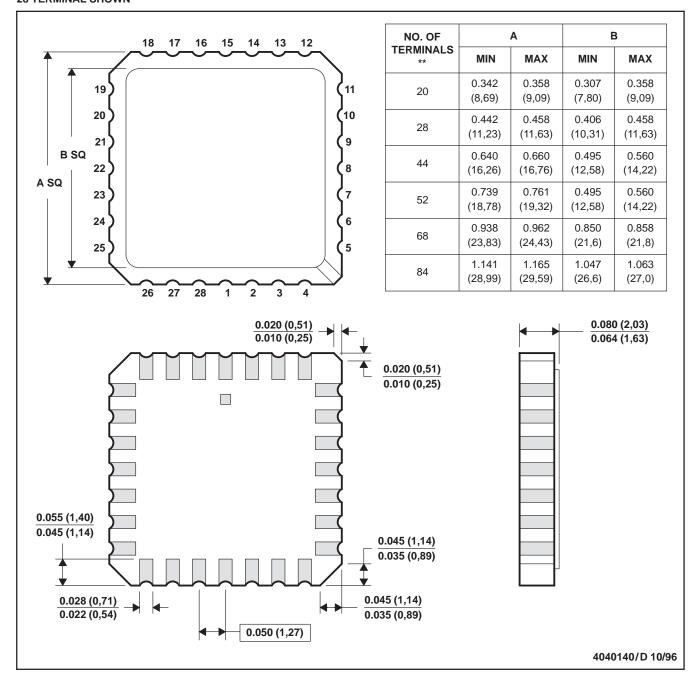
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



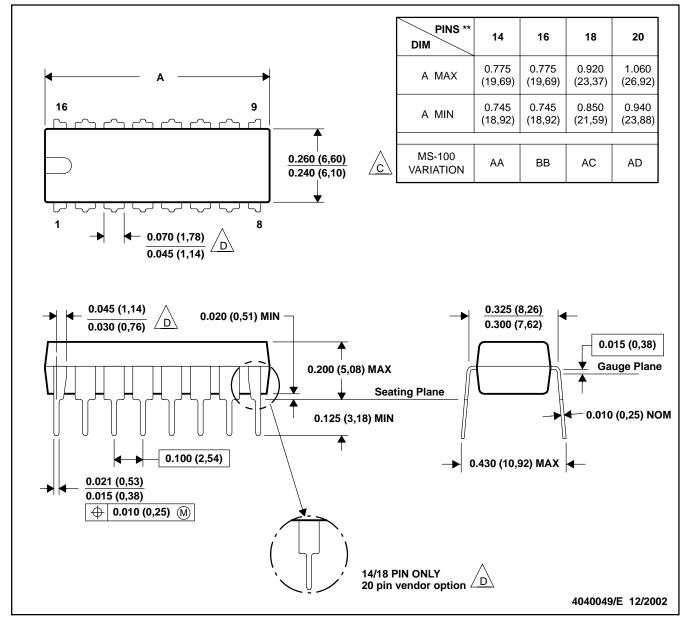
- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MS-004



N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

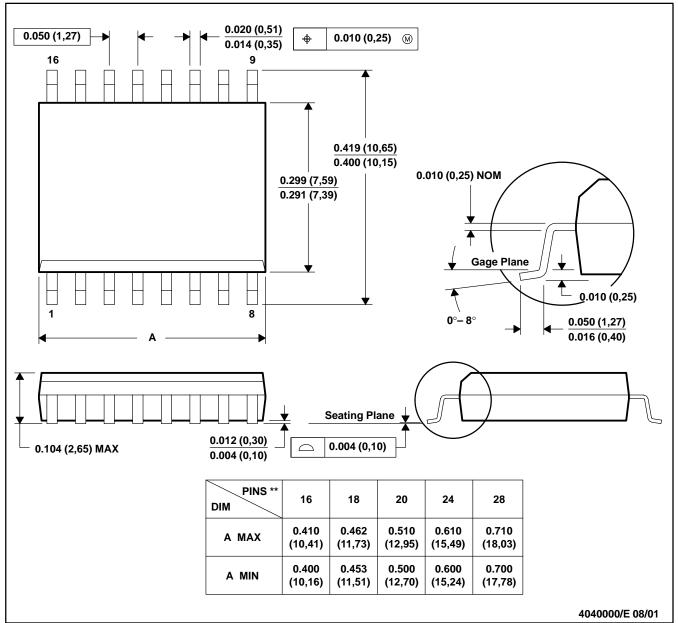
Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).

The 20 pin end lead shoulder width is a vendor option, either half or full width.

DW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-013

MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

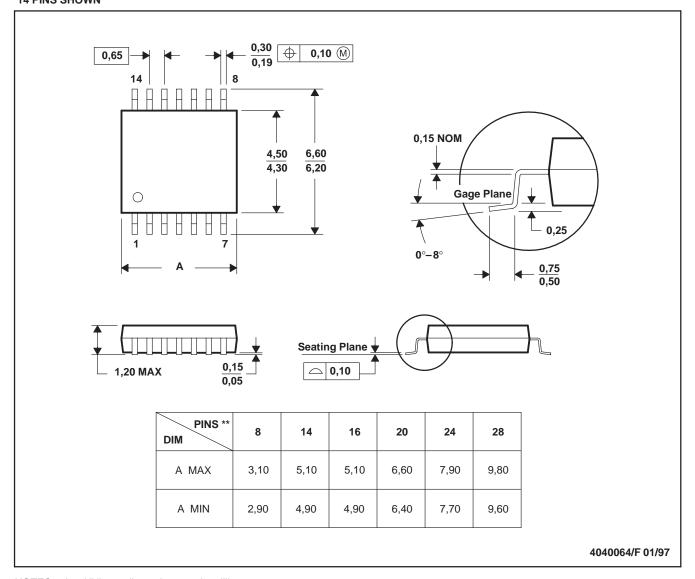
- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265

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